

Features :

- n Isolated mounting base 2500V~
- n Pressure contact technology with Increased power cycling capability
- n Space and weight saving

Typical Applications :

- n Inverter
- n Inductive heating
- n Chopper

V _{RRM} , V _{DRM}	Type & Outline	
600V	MKx200-06-413F3D	MHx200-06-413F3D
800V	MKx200-08-413F3D	MHx200-08-413F3D
1000V	MKx200-10-413F3D	MHx200-10-413F3D
1200V	MKx200-12-413F3D	MHx200-12-413F3D
1400V	MKx200-14-413F3D	MHx200-14-413F3D
1600V	MKx200-16-413F3D	MHx200-16-413F3D
1800V	MKx200-18-413F3D	MHx200-18-413F3D
1800V	MK200-18-413F3DG	

MKx stands for any type of **MKC, MKA, MKK**
 MHx stands for any type of **MHC, MHA, MHK**

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT	
				Min	Type	Max		
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =85°C	125			200	A	
I _{T(RMS)}	RMS on-state current					314	A	
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			50	mA	
I _{TSM}	Surge on-state current	10ms half sine wave	125			4.8	kA	
I ² t	I ² t for fusing coordination	V _R =60%V _{RRM}				115	10 ³ A ² s	
V _{TO}	Threshold voltage		125			1.65	V	
r _T	On-state slope resistance					0.60	m	
V _{TM}	Peak on-state voltage	I _{TM} =600A	25			2.65	V	
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			800	V/μs	
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t _r ≤0.5μs Repetitive	125			200	A/μs	
t _q	Circuit commutated turn-off time	I _{TM} =200A, t _p =4000μs, V _R =100V dv/dt=30V/μs, di/dt=-20A/μs	125	20		40	μs	
			25	6		16	μs	
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25			30	mA	
V _{GT}	Gate trigger voltage					0.8	2.5	V
I _H	Holding current					20	200	mA
I _L	Latching current						1000	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125			0.2	V	
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled per chip				0.100	°C /W	
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled per chip				0.040	°C /W	
V _{iso}	Isolation voltage	50Hz, R.M.S, t=1min, I _{iso} : 1mA(MAX)		2500			V	
F _m	Terminal connection torque(M8)			10.0		12.0	N·m	
	Mounting torque(M6)			4.5		6.0	N·m	
T _{vj}	Junction temperature			-40		125	°C	
T _{stg}	Stored temperature			-40		125	°C	
W _t	Weight				770		g	
Outline	413F3D							

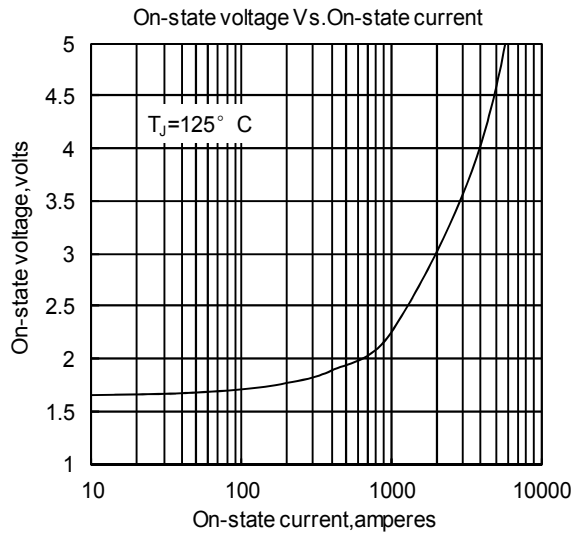


Fig.1

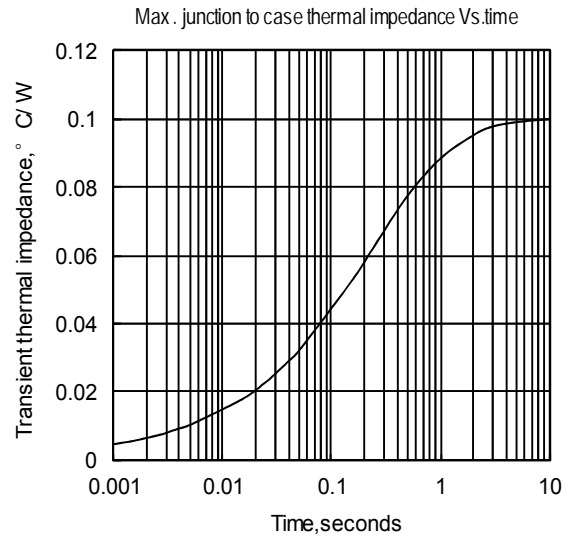


Fig.2

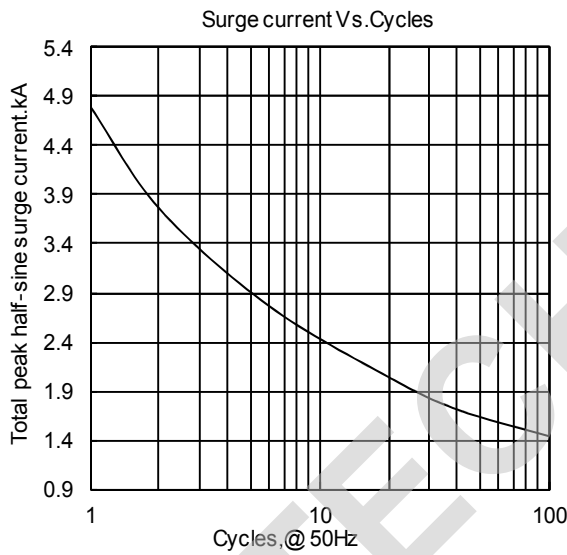


Fig.3

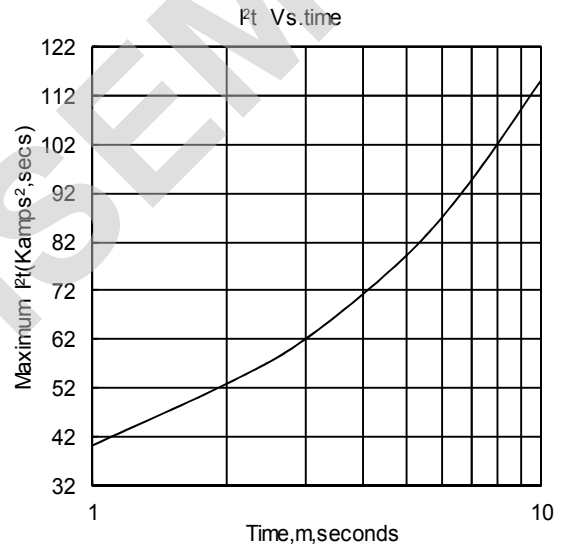


Fig.4

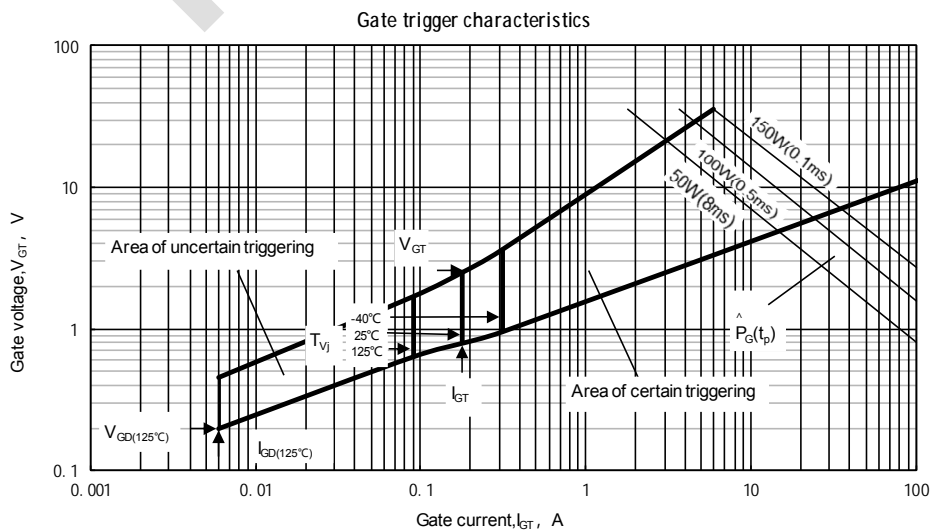
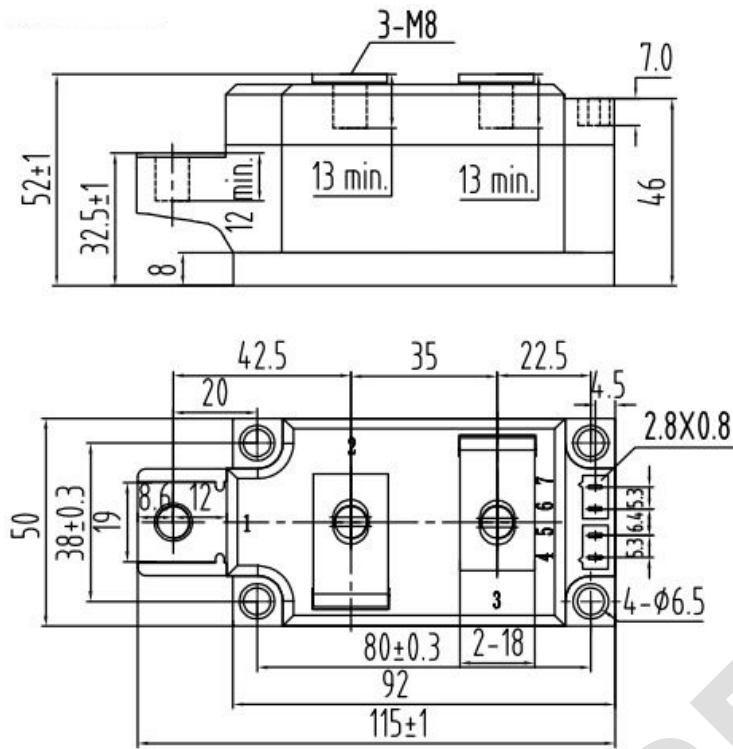


Fig.5

Outline:



Unmarked dimensional tolerance: ±0.5mm

TECHSEM reserves the right to change specifications without notice.

